January 1997



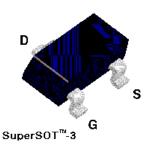
NDS355AN N-Channel Logic Level Enhancement Mode Field Effect Transistor

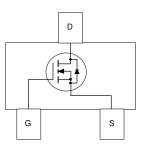
General Description

SuperSOT[™]-3 N-Channel logic level enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMCIA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package.

Features

- 1.7A, 30 V, $R_{DS(ON)} = 0.125 \Omega @ V_{GS} = 4.5 V$ $R_{DS(ON)} = 0.085 \Omega @ V_{GS} = 10 V.$
- Industry standard outline SOT-23 surface mount package using proprietary SuperSOT[™]-3 design for superior thermal and electrical capabilities.
- High density cell design for extremely low R_{DS(ON)}.
- Exceptional on-resistance and maximum DC current capability.
- Compact industry standard SOT-23 surface mount package.

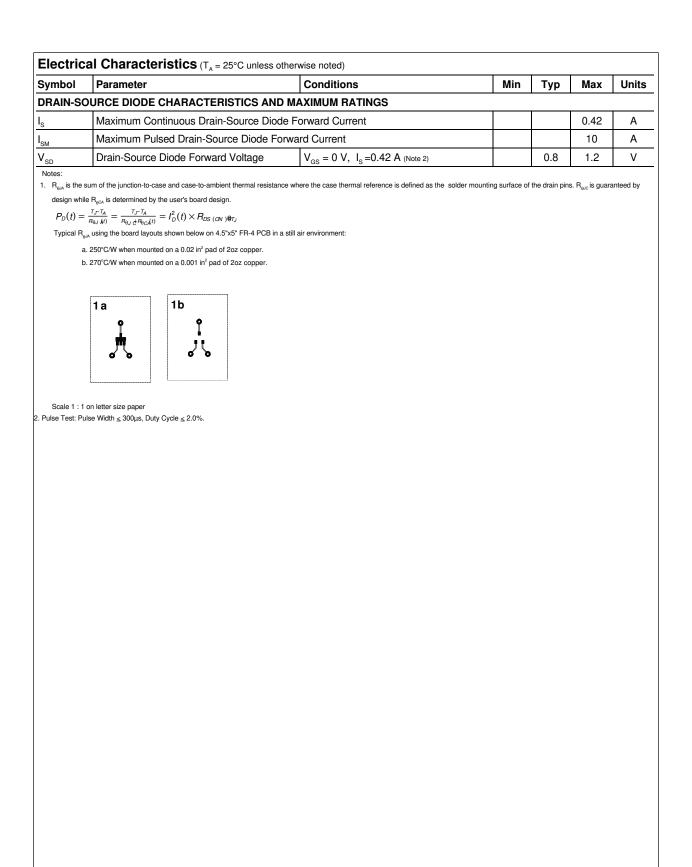




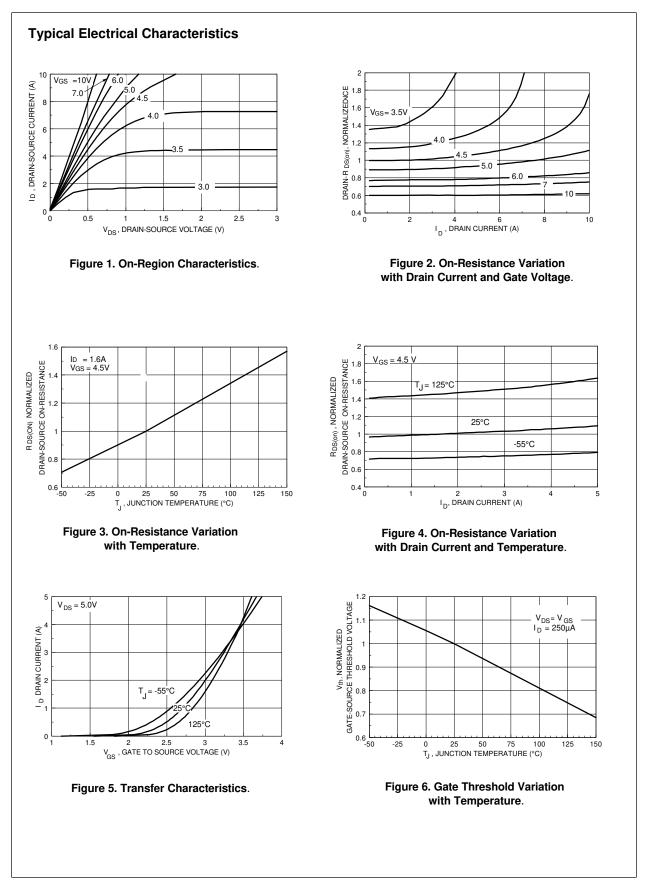
Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		NDS355AN	Units	
V _{DSS}	Drain-Source Voltage Gate-Source Voltage - Continuous		30	V	
V _{GSS}			±20	V	
I _D	Maximum Drain Current - Continuous	(Note 1a)	1.7	А	
	- Pulsed		10		
P _D	Maximum Power Dissipation	(Note 1a)	0.5	W	
		(Note 1b)	0.46		
T _J ,T _{stg}	Operating and Storage Temperature Range		-55 to 150	°C	
THERMA	L CHARACTERISTICS				
R _{eja}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W	
R _{ejc}	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W	

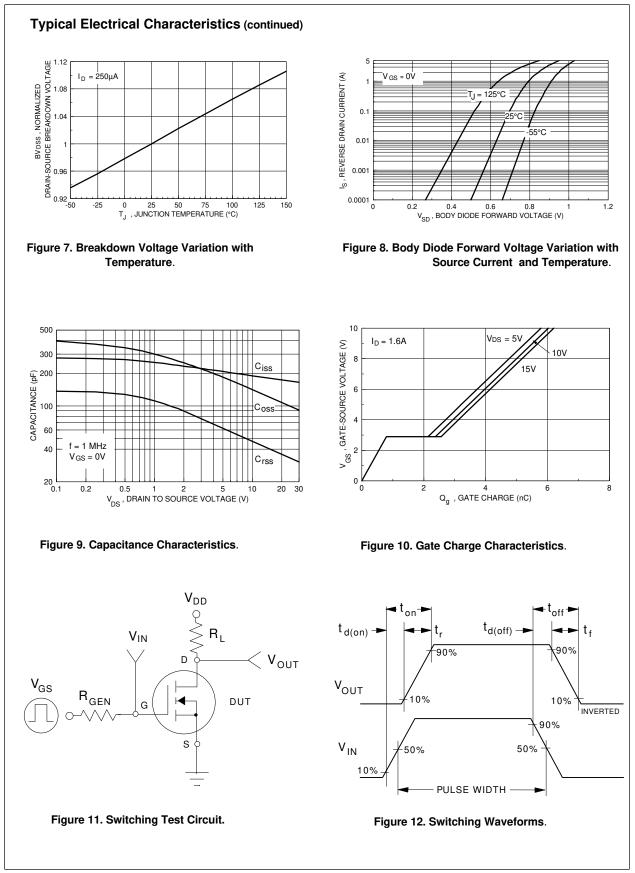
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{_{GS}} = 0 V, I_{_{D}} = 250 \ \mu A$		30			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\rm DS} = 24 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V}$				1	μA
			T _J =125°C			10	μA
	Gate - Body Leakage, Forward	$V_{GS} = 20 V_{DS} = 0 V$				100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAF	ACTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = 250 \ \mu A$		1	1.6	2	V
			T _J =125°C	0.5	1.2	1.5	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = 4.5 V, I _D = 1.7 A			0.105	0.125	Ω
			T _J =125°C		0.16	0.23	
		V _{GS} = 10 V, I _D = 1.9 A			0.065	0.085	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$		6			Α
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 1.7 \text{ A}$			3.5		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1.0 MHz			195		pF
C _{oss}	Output Capacitance				135		pF
C _{rss}	Reverse Transfer Capacitance				48		pF
SWITCHI	NG CHARACTERISTICS (Note 2)						
t _{d(on)}	Turn - On Delay Time	$V_{\text{DD}} = 10 \text{ V}, \text{ I}_{\text{D}} = 1 \text{ A}, \\ V_{\text{GS}} = 10 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$			10	20	ns
t,	Turn - On Rise Time				13	25	ns
t _{d(off)}	Turn - Off Delay Time				13	25	ns
t,	Turn - Off Fall Time				4	10	ns
t _{d(on)}	Turn - On Delay Time	$V_{_{DD}} = 5 V, I_{_{D}} = 1 A,$			10	20	ns
t,	Turn - On Rise Time	$V_{GS} = 4.5 \text{ V}, \ \text{R}_{\text{GEN}} = 6 \ \Omega$			32	60	ns
t _{d(off)}	Turn - Off Delay Time				10	20	ns
t _r	Turn - Off Fall Time				5	10	ns
Q _g	Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.7 \text{ A},$			3.5	5	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$			0.8		nC
Q _{gd}	Gate-Drain Charge				1.7		nC

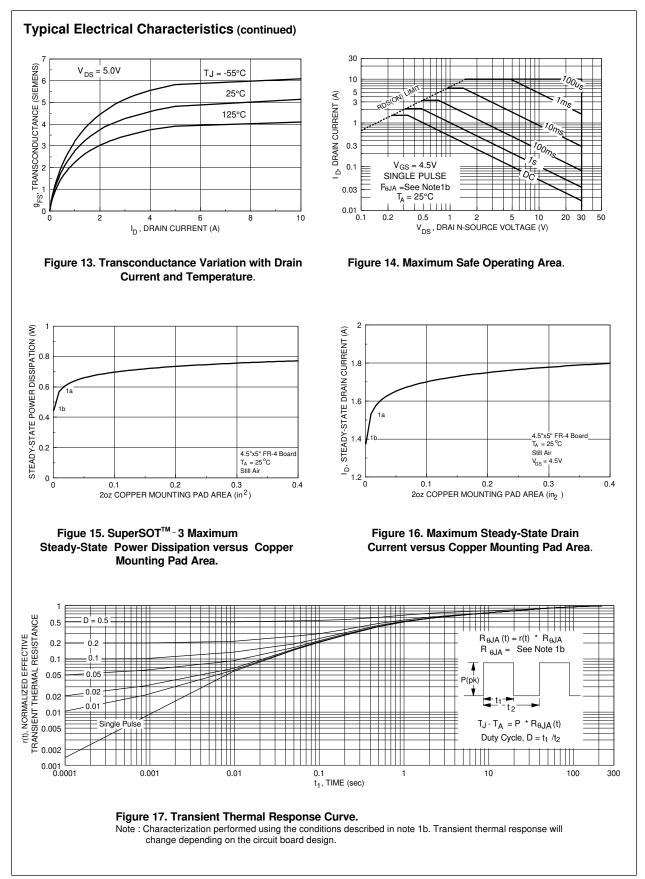


NDS355AN Rev.C



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